# **DA6X109W**

## Silicon epitaxial planar type

For high speed switching circuits DA5J109W in Mini6 type package

#### ■ Features

- Short reverse recovery time t<sub>rr</sub>
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

#### ■ Basic Part Number

#### Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

### ■ Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Reverse voltage	$V_R$	80	V	
Maximum peak reverse voltage	V <sub>RM</sub>	80	V	
Forward current	$I_{\mathrm{F}}$	100	mA	
Peak forward current *1	$I_{FM}$	225	mA	
Non-repetitive peak forward surge current *2	I <sub>FSM</sub>	500	mA	
Junction temperature	$T_{j}$	150	%C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

Note) \*1: Value for single diode

\*2: 1 t = 1 s

#### ■ Package

Code

Mini6-G4-B

Pin Name

1: Anode-1 4: Anode-3

2: Cathode-1, 2, 3, 4 5: Cathode-1, 2, 3, 4

3: Anode-2 6: Anode-4

■ Marking Symbol: 28

#### Internal Connection

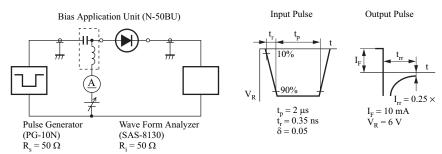


#### ■ Electrical Characteristics $T_a = 25$ °C±3°C

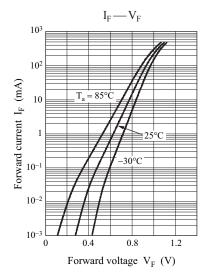
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\mathrm{F}}$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage	V <sub>R</sub>	$I_R = 100 \mu A$	80			V
Reverse current	$I_R$	$V_R = 80 V$			100	nA
Terminal capacitance	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$			2	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}, I_{rr} = 0.25 \times I_R$			3	ns

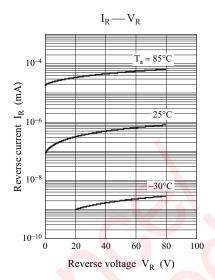
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

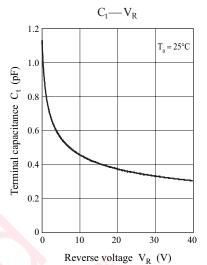
- 2. Absolute frequency of input and output is  $100\ \text{MHz}$
- 3. \*: t<sub>rr</sub> measurement circuit



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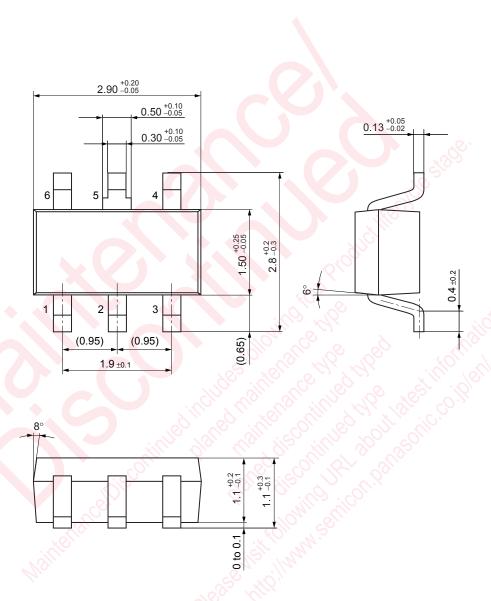




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Mini6-G4-B Unit: mm



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